



#### SURFACE MOUNT SWITCHING DIODE

#### **Features**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking Information: See Page 2Type Code: BAV19W: A8 or T2 or T3

BAV20W: T2 or T3 BAV21W: T3

Ordering Information: See Page 2Weight: 0.01 grams (approximate)

SOD-123



**TOP VIEW** 

### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	BAV19W	BAV20W	BAV21W	Unit
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	120	200	250	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	150	200	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	71	106	141	V
Forward Continuous Current	I <sub>FM</sub>		400			
Average Rectified Output Current	lo	200				
Non-Repetitive Peak Forward Surge Current	I <sub>FSM</sub>	2.5 0.5			А	
Repetitive Peak Forward Surge Current	I <sub>FRM</sub>	625				

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P <sub>D</sub>	250	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

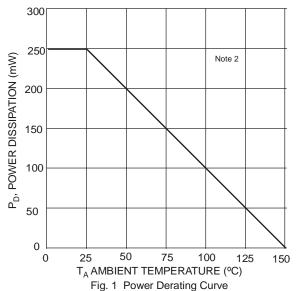
### **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

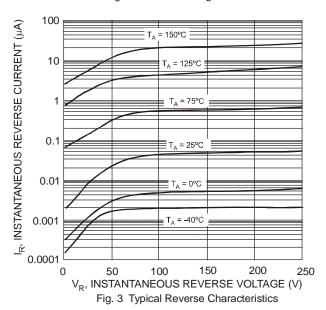
Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 1)	BAV19W BAV20W BAV21W	V <sub>(BR)R</sub>	120 200 250	_	V	I <sub>R</sub> = 100μA	
Forward Voltage		V <sub>FM</sub>	_	1.0 1.25	V	$I_F = 100 \text{mA}$ $I_F = 200 \text{mA}$	
Peak Reverse Current  @ Rated DC Blocking Voltage (Note 1)		I <sub>RM</sub>	_	100 15	nA μA	$T_{J} = 25^{\circ}C$ $T_{J} = 100^{\circ}C$	
Total Capacitance		Ст	_	5.0	pF	$V_R = 0, f = 1.0MHz$	
Reverse Recovery Time		t <sub>rr</sub>	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \text{W}$	

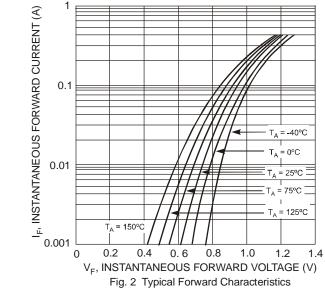
Notes:

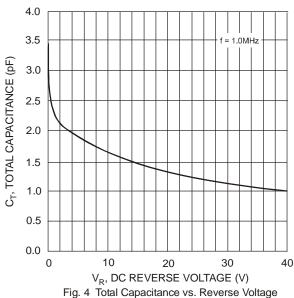
- 1. Short duration pulse test used to minimize self-heating effect.
- Part mounted on FR-4 PC board with minimum recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Čode V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









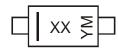


## **Ordering Information** (Note 5)

Part Number	Case	Packaging
BAV19W-7-F	SOD-123	3000/Tape and Reel
BAV20W-7-F	SOD-123	3000/Tape and Reel
BAV21W-7-F	SOD-123	3000/Tape and Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



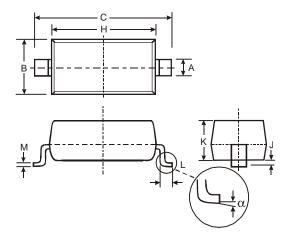
XX = Product Type Marking Code (See Page 1) YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	N	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b I	Mar	Apr	May	Jui	n	Jul	Aug	Sep	Oct	t	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

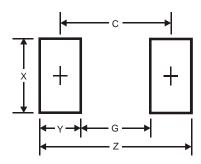


# **Package Outline Dimensions**



SOD-123						
Dim	Min	Max				
Α	0.55 Typ					
В	1.40	1.70				
С	3.55	3.85				
Н	2.55	2.85				
J	0.00	0.10				
K	1.00	1.35				
L	0.25	0.40				
M	0.10	0.15				
α	0	8°				
All Di	All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Υ	1.2
С	3.7



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